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## APPLICATION DATA SHEET

Electronic Version v1.4

Stylesheet Version v1.4.0

<b>Title of Invention</b>	<b>INTEGRATED CIRCUIT WITH PROTECTED IMPLANTATION PROFILES AND METHOD FOR THE FORMATION THEREOF</b>
<b>Application Type:</b> regular, utility <b>Attorney Docket Number:</b> 1016-024	
<b>Correspondence address:</b> <b>Customer Number:</b> 22898 <b>*22898*</b>	
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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

**Publication Information:**

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**Suggested Figure for Publication – FIG. 5****Suggested Classification –****Suggested Technology Center –****Total Number of Drawing Sheets – 4****Assignee 1:****Organization Name:****CHARTERED SEMICONDUCTOR MANUFACTURING  
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